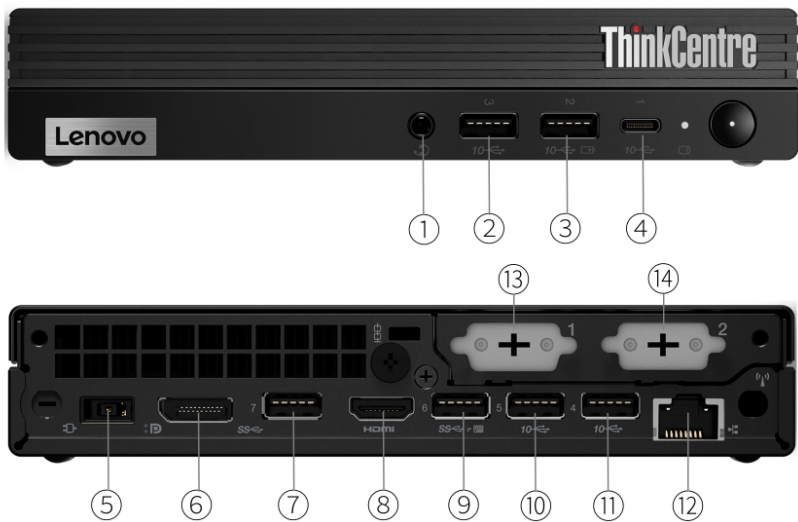


OVERVIEW



1. Headphone / microphone combo jack (3.5mm)	8. HDMI
2. USB 3.2 Gen 2	9. USB 3.2 Gen 1 (with Smart Power On)
3. USB 3.2 Gen 2 (Always On and fast charge)	10. USB 3.2 Gen 2
4. USB-C 3.2 Gen 2	11. USB 3.2 Gen 2
5. Power connector	12. Ethernet (RJ-45)
6. DisplayPort 1.4	13. Punch out port 1 *
7. USB 3.2 Gen 1	14. Punch out port 2 *

Notes:

- Items with \* are only available on selected models

PERFORMANCE

Processor

Processor Family

Intel® Celeron®, Intel® Pentium®, or 12th Generation Intel® Core™ i3 / i5 / i7 / i9 Processor

Processor\*\*

Processor Name	Cores	Threads	Base Frequency	Max Frequency	Cache	Memory Support	Processor Graphics
Celeron® G6900T	2	2	2.8GHz	-	4MB	DDR5-4800	Intel® UHD Graphics 710
Pentium® Gold G7400T	2	4	3.1GHz	-	6MB	DDR5-4800	Intel® UHD Graphics 710
Core i3-12100T	4 (4 P-core + 0 E-core)	8	P-core 2.2GHz	P-core 4.1GHz <sup>[1]</sup>	12MB	DDR5-4800	Intel® UHD Graphics 730
Core i3-12300T	4 (4 P-core + 0 E-core)	8	P-core 2.3GHz	P-core 4.2GHz <sup>[2]</sup>	12MB	DDR5-4800	Intel® UHD Graphics 730
Core i5-12400T	6 (6 P-core + 0 E-core)	12	P-core 1.8GHz	P-core 4.2GHz <sup>[3]</sup>	18MB	DDR5-4800	Intel® UHD Graphics 730
Core i5-12500T	6 (6 P-core + 0 E-core)	12	P-core 2.0GHz	P-core 4.4GHz <sup>[4]</sup>	18MB	DDR5-4800	Intel® UHD Graphics 770
Core i5-12600T	6 (6 P-core + 0 E-core)	12	P-core 2.1GHz	P-core 4.6GHz <sup>[5]</sup>	18MB	DDR5-4800	Intel® UHD Graphics 770
Core i7-12700T	12 (8 P-core + 4 E-core)	20	P-core 1.4GHz / E-core 1.0GHz	Max Turbo up to 4.7GHz / P-core 4.6GHz / E-core 3.4GHz <sup>[6]</sup>	25MB	DDR5-4800	Intel® UHD Graphics 770
Core i9-12900T	16 (8 P-core + 8 E-core)	24	P-core 1.4GHz / E-core 1.0GHz	Max Turbo up to 4.9GHz / P-core 4.8GHz / E-core 3.6GHz <sup>[7]</sup>	30MB	DDR5-4800	Intel® UHD Graphics 770

Notes:

[1], [2], [3], [4], [5], [6], [7] Intel® Max Turbo frequency will vary depending on application workload and the hardware and software configurations, see <http://www.intel.com/technology/turboboost/> for more information.

Operating System

Operating System\*\*<sup>[1]</sup>

- Windows® 11 Pro
- Windows® 11 Home
- Windows® 11 Home Single Language
- Windows® 11 DG Windows® 10 Pro 64
- Windows® 10 IoT Enterprise LTSC 2021
- Ubuntu Linux
- Red Hat Enterprise Linux 8.6 (certified only, for detailed and latest information, please visit [Red Hat Certified Hardware](#))
- No preload operating system

Notes:

[1] Windows® 10 IoT Enterprise LTSC 2021 is for special bid only.

Graphics

Graphics\*\*

Graphics	Type	Memory	Max Resolution	Connector	Key Features
Intel® UHD graphics	Integrated	Shared	4096x2160@60Hz(HDMI®), 1920x1200@60Hz(VGA),	1x HDMI® 2.1 TMDS, 1x DP 1.4, 2x punch out ports(2x	DirectX® 12

710			4096x2160@60Hz(DP), 4096x2160@60Hz(USB-C® with DP function)	HDMI®/VGA/DP] or [USB-C® with DP function, HDMI®/VGA/DP])	
Intel® UHD graphics 730	Integrated	Shared	4096x2160@60Hz(HDMI®), 1920x1200@60Hz(VGA), 4096x2304@60Hz(DP), 4096x2304@60Hz(USB-C® with DP function)	1x HDMI® 2.1 TMDS, 1x DP 1.4, 2x punch out ports([2x HDMI®/VGA/DP] or [USB-C® with DP function, HDMI®/VGA/DP])	DirectX® 12
Intel® UHD graphics 770	Integrated	Shared	4096x2160@60Hz(HDMI®), 1920x1200@60Hz(VGA), 4096x2304@60Hz(DP), 4096x2304@60Hz(USB-C® with DP function)	1x HDMI® 2.1 TMDS, 1x DP 1.4, 2x punch out ports([2x HDMI®/VGA/DP] or [USB-C® with DP function, HDMI®/VGA/DP])	DirectX® 12

Monitor Support

Monitor Support

Supports up to 4 independent displays via (onboard DP, onboard HDMI®, optional punch out port 1 [VGA / HDMI® / DP / USB-C®], and optional punch out port 2 [VGA / HDMI® / DP])

Chipset

Chipset

Intel® Q670 chipset

Memory

Max Memory<sup>[1]</sup>

Up to 64GB DDR5-4800

Memory Slots

Two DDR5 SO-DIMM slots, dual-channel capable

Memory Type

DDR5-4800

Notes:

[1] The max memory is based on the test results with current Lenovo® memory offerings.

Storage

Storage Support<sup>[1]</sup>

Up to three drives, 1x 2.5" HDD + 2x M.2 SSD

- 2.5" HDD up to 1TB
- M.2 SSD up to 2TB each

Storage Type<sup>\*\*\*</sup>

Disk Type	Interface	RPM	Offering	Security
2.5" SATA HDD	SATA 6Gb/s	7.2K	500GB / 1TB	-
M.2 2242 SSD	PCIe® NVMe®, PCIe® 3.0 x2	-	128GB	-
M.2 2280 SSD	PCIe® NVMe®, PCIe® 4.0 x4	-	256GB / 512GB / 1TB	Opal 2.0
M.2 2280 SSD	PCIe® NVMe®, PCIe® 4.0 x4 Performance	-	512GB / 1TB / 2TB	Opal 2.0

RAID

RAID 0/1 support for M.2 SSDs (RAID preset only available via special bid models)

Notes:

[1] The max capacity of each disk type is based on the test results with current Lenovo® storage offerings.

Removable Storage

Optical<sup>\*\*</sup>

- DVD-ROM, slim (9.0mm), via USB external ODD box

- DVD burner (DVD±RW), slim (9.0mm), via USB external ODD box
- None

Card Reader

No card reader

Multi-Media

Audio Chip

High Definition (HD) Audio, Realtek® ALC256VB codec

Speakers\*\*

- Premium single speaker, 2W x1
- Single speaker, 2W x1

Microphone

No microphone

Power Supply

Power Supply\*\*

Power	Type	Efficiency	Key Features
65W	Adapter	89%	Autosensing
90W	Adapter	89%	Autosensing
135W	Adapter	89%	Autosensing
No power supply	-	-	-

DESIGN

Input Device

Keyboard\*\*

- Lenovo® Calliope Keyboard (USB connector), black
- Lenovo® Calliope Wireless Keyboard, black
- Lenovo® Traditional Keyboard (USB connector), black
- No keyboard

Mouse\*\*

- Lenovo® Calliope Mouse (USB connector), black
- Lenovo® Calliope Wireless Mouse (2.4GHz via USB receiver), black
- Lenovo® Fingerprint Mouse (USB connector), black (EOL on Jan, 2023)
- No mouse

Mechanical

Form Factor

Tiny (1L)

Dimensions (WxDxH)<sup>[1]</sup>

Models	Dimensions
Tiny only	179 x 182.9 x 36.5 mm with rubber feet (7.05 x 7.2 x 1.44 inches)
Tiny & ODD	204.2 x 186.6 x 64 mm with rubber feet (8.04 x 7.35 x 2.52 inches with rubber feet)

Packaging Dimensions (WxDxH)<sup>[2]</sup>

- Tiny only: 490 x 250 x 130 mm (19.29 x 9.84 x 5.12 inches)
- Tiny & ODD: 490 x 268 x 166 mm (19.29 x 10.55 x 6.54 inches)

Weight<sup>[3]</sup>

Models	Weight
Tiny only	1.25 kg (2.76 lbs)
With VESA mount & ODD box	1.74 kg (3.84 lbs)

Packaging Weight<sup>[4]</sup>

- Tiny only: Around 3.2 kg (7.05 lbs)
- Tiny & ODD: Around 3.9 kg (8.6 lbs)

**Case Color**

Black

**Bays**

1x 2.5" disk bay

**Expansion Slots**

- Two M.2 PCIe® Gen 4x4 slots (for SSD)
- One M.2 slot (for WLAN)

**EOU**

- (Optional) toolless chassis open (toolless chassis screw required) and toolless M.2 SSD, HDD, memory assembly / removal
- No support

**Stand**

- Vertical stand
- No stand

**IO Box**

No IO box

**Mounting**

- VESA mount bracket kit, supports VESA mount 75mm and 100mm
- None

**Others**

- (Optional) Dust filter
- (Optional) Power adapter cage

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**Notes:**

[1] The system dimensions may vary depending on configurations.

[2] The new packages take effect from September 2023. The old packages are:

Tiny only: 500 x 150 x 280 mm (19.69 x 5.91 x 11.02 inches)

Tiny & ODD: 500 x 175 x 280 mm (19.69 x 6.89 x 11.02 inches)

[3] The system weight is approximate and based on results in Lenovo® lab, which varies depending on the source of component, variance of the distribution of each component, and manufacturing process. It may not be the exact weight for each specific model.

[4] The new packages take effect from September 2023. The old package are:

Tiny only: 2.85 kg (6.28 lbs)

Tiny & ODD: 3.58 kg (7.89 lbs)

## CONNECTIVITY

### Network

**Onboard Ethernet**

Gigabit Ethernet, Intel® Ethernet Connection I219-LM, 1x RJ-45, supports Wake-on-LAN

**Optional Ethernet**

- 2.5 Gigabit Ethernet, Realtek® RTL8125BGS, 1x RJ-45, supports Wake-on-LAN
- No optional Ethernet

**WLAN + Bluetooth®\*\***

- Realtek® Wi-Fi® 6 RTL8852BE, 802.11ax Dual Band 2x2 Wi-Fi® + Bluetooth® 5.3, M.2 card<sup>[1]</sup>
- Intel® Wi-Fi® 6 AX201, 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.2, M.2 Card<sup>[2]</sup>
- AMD Wi-Fi® 6E RZ616, 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.3, M.2 Card<sup>[3]</sup>
- Intel® Wi-Fi® 6E AX211, 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.3, Intel® vPro® technology support, M.2 Card<sup>[4]</sup>
- No WLAN and Bluetooth®

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**Notes:**

[1], [3], [4] Bluetooth® 5.3 requires Windows® 11.

[2] Bluetooth® 5.2 requires Windows® 11.

## Ports<sup>[1]</sup>

### Front Ports

- 1x USB-C® 3.2 Gen 2 (support data transfer)
- 1x USB 3.2 Gen 2 (Always On and 5V@2.1A charging)
- 1x USB 3.2 Gen 2
- 1x headphone / microphone combo jack (3.5mm)

### Optional Front Ports

None

### Rear Ports

- 2x USB 3.2 Gen 1 (one supports Smart Power On)
- 2x USB 3.2 Gen 2
- 1x HDMI® 2.1 TMDS
- 1x DisplayPort™ 1.4
- 1x Ethernet (RJ-45)

### Optional Rear Ports

- Punch out port 2 (one of VGA / DisplayPort™ / HDMI® / serial / RJ-45)
- 2x USB 3.2 Gen 1 (share one USB 3.2 Gen 1 bandwidth, occupies port 1 and 2)
- 4x USB 3.2 Gen 1 (share one USB 3.2 Gen 1 bandwidth, occupy port 1 and 2)
- 1x 2.5GbE RJ-45, via RTL8125BGS
- Punch out port 1 (one of VGA / DisplayPort™ / HDMI® / serial / USB-C® 3.2 Gen 1 with DisplayPort™ functions 100W PD in)

### Notes:

[1] The transfer speed of following ports will vary and, depending on many factors, such as the processing speed of the host device, file attributes and other factors related to system configuration and your operating environment, will be slower than theoretical speed.

USB 2.0: 480 Mbit/s;

USB 3.2 Gen 1 (SuperSpeed USB 5Gbps, formerly USB 3.0 / USB 3.1 Gen 1): 5 Gbit/s;

USB 3.2 Gen 2 (SuperSpeed USB 10Gbps, formerly USB 3.1 Gen 2): 10 Gbit/s;

USB4® 20Gbps / USB 3.2 Gen 2x2 (SuperSpeed USB 20Gbps): 20 Gbit/s;

USB4® 40Gbps (USB 40Gbps): 40 Gbit/s;

Thunderbolt™ 3/4: 40 Gbit/s.

## SECURITY & PRIVACY

### Security

#### Security Chip

Discrete TPM 2.0, TCG certified, FIPS 140-2 certified

#### Physical Locks

Kensington® Security Slot™, 3 x 7 mm

#### Chassis Intrusion Switch

Chassis intrusion switch<sup>[1]</sup>

#### Fingerprint Reader

- Touch style fingerprint reader on mouse (EOL on Jan, 2023)
- No fingerprint reader

#### BIOS Security

- Administrator password
- Power-on password
- Hard disk password
- Boot sequence control
- Boot without keyboard and mouse
- Certificate based BIOS management
- Cover presence switch
- Individual USB port disablement
- Self-healing BIOS
- Smart USB protection (allows keyboard / mouse only, blocks all storage devices)

Notes:

[1] Chassis intrusion switch is hardware ready function and needs to be special bid or manually enabled in BIOS.

## MANAGEABILITY

### System Management

#### System Management\*\*

- Intel® vPro® Enterprise<sup>[1]</sup>
- Intel® vPro® Essentials<sup>[2]</sup>
- Non-vPro®

Notes:

[1], [2] Intel® vPro® offers a superset of DASH's defined capabilities.

## SERVICE

### Warranty<sup>[1]</sup>

#### Base Warranty\*\*

- 1-year courier or carry-in service
- 1-year limited onsite service
- 3-year limited onsite service
- No base warranty

Notes:

[1] The warranty upgrades may be bundled with some models, please check the "Included upgrade" column in the specific model's configurations. For more service extensions, please go to <https://smartfind.lenovo.com/>. To learn more details of warranty policy, please access <https://support.lenovo.com/warrantylookup/warrantypolicy>.

## ACCESSORIES

### Bundled Accessories

#### Bundled Accessories

- DP to DVI dongle
- DP to Dual DP dongle
- DP to HDMI® dongle
- DP to VGA dongle
- HDMI® to HDMI® cable (1.5m)
- HDMI® to VGA dongle
- None

## OPERATING REQUIREMENTS

### Operating Environment

#### Temperature

- Operating: 5°C (41°F) to 35°C (95°F)
- Storage: -40°C (-40°F) to 60°C (140°F)

#### Relative Humidity

- Operating: 20% to 80%
- Storage: 10% to 90%

#### Altitude

- Operating: 0 m (0 ft) to 3048 m (10,000 ft)
- Storage: 0 m (0 ft) to 12192 m (40,000 ft)

## ENVIRONMENTAL

## Sustainability

### Material<sup>[1]</sup>

85% PCC recycled plastic used in product chassis  
95% PCC recycled plastic used in USB keyboard/mouse  
90% PIC recycled plastic EPE cushion or 90% PCC recycled plastic thermal shell with 30% OBP material  
30% OBP used in bag  
FSC certified paper in packaging

#### Notes:

[1] PCC: Post Consumer Content, recycled materials from customers.

PIC: Post Industry Content, recycled materials from internal factories.

EPE: Expanded Polyethylene.

OBP: Ocean Bound Plastic, reducing plastic spill into the sea.

FSC: Forest Stewardship Council.

## CERTIFICATIONS

### Green Certifications<sup>[1]</sup>

#### Green Certifications

- (Optional) ENERGY STAR® 8.0
- (Optional) EPEAT™ Silver Registered<sup>[2]</sup>
- ErP Lot 3
- RoHS compliant
- TCO Certified 9.0

#### Notes:

[1] The items listed under the "Green Certifications" section may not only refer to certification but also registration or self-declaration. For ESG & regulatory compliance documents, please visit <https://compliance.lenovo.com>.

[2] EPEAT™ is registered where applicable, please visit [epeat.net](https://epeat.net) for registration status by country.

### Other Certifications

#### Other Certifications

(Optional) TÜV Rheinland® Ultra Low Noise

#### Mil-Spec Test

MIL-STD-810H military test passed

- Feature with \*\* means that only one offering listed under the feature is configured on selected models.
- Feature with \*\*\* means that one or more offerings listed under the feature could be configured on selected models.
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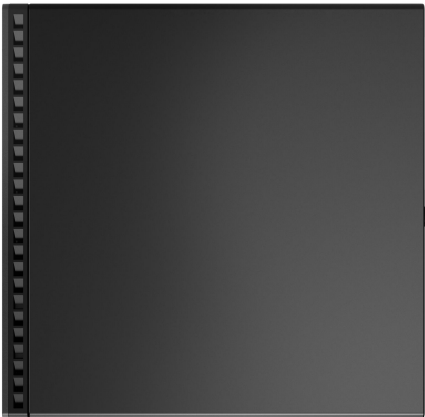
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